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		^{US-} 6,454,855	09/24/2002	VON KAENEL et al.	entire document
· · ·		^{US-} 2002/0056414	05/16/2002	SHIM et al.	entire document
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		EP 1 315 199	05/28/2003	VON KAENEL	entire document	
		WO/1998/058099	12/23/1998	VON KAENEL et al.	entire document	
		WO/2003/044839	05/30/2003	VON KAENEL	entire document	
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STATEMENT BY APPLICANT (Use as many sheets as necessary)				First Named Inventor	VON KAENEL, Hans		
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Sheet 2		of	4	Attorney Docket Number	PUS-E005-013		

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Examiner Initials*	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T ²
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Signature	/Sonya McCall-Shepard/	Considered	03/20/2009

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Signature	/Sonya McCall-Shepard/	Considered	03/20/2009

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